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 Safety Standard Certified Resin Molding SMD Type Ceramic
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 Capacitors for General Purpose SYW Series (Y1:250V~/400V~)
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CUSTOMER: DOC. NO.: POE-D31-00-E-01 APPROVED BY CUSTOMER PROVED BY CUSTOMER Provention Customer Provention Provention	HF PRODUCT SPECIFICATION PRODUCT: Safety Standard Certified Resin Molding SMD Type Ceramic Capacitors for General Purpose TYPE: SYW SERIES (V1.250V~/400V~)
DOC. NO.: POE-D31-00-E-01	CUSTOMER:
APPROVED BY CUSTOMER ASSIVE BYSTEM ALLIANCE VENDOR: ASSIVE BYSTEM ALLIANCE VENDOR: ASSIVE BYSTEM ALLIANCE	DOC. NO.: <u>POE-D31-00-E-01</u>
ZONE,DALANGTOWN,DONGGUAN CITY, GUANGDONG PROVINCE	APPROVED BY CUSTOMER PASSIVE SYSTEM ALLIANCE PAS

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Record of change

Date	Version	Description	page
2021/1/7	00	1. First edition.	All
2021/6/30	01	2. Add "HF" logo 1	1





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1. Part number for SAP system:

(1) Temperature characteristic (identified code)

CODE	Temperature characteristic	Cap. Change
SL	SL	-1000~+350PPM/℃ (+20℃~+85℃)
YP	B (Y5P)	±10%
YU	E (Y5U)	-56% to +22%
YV	F(Y5V)	-82% to +22%

(2) SMD Type : SYW (Y1:250Vac/400Vac)

(3) Capacitance (identified by 3-figure code):ex. 221=220pF, 102=1000pF

(4) Capacitance tolerance (identified by code): J:±5%,K:±10%,M:±20%

(5) Special Specification Code :

Code	Description
Р	Pb Solder Product

(6) Internal code: 00--Normal, other code--Special control



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2. Mechanical: Encapsulation : Epoxy resin, flammability UL94 V-0



	Dimension(mm)								
L	7.8±0.1	W1	2.5±0.05						
W	5.4±0.1	Т	0.13±0.02						
н	2.38±0.05	H1	0.05±0.03						
L1	9.6±0.2	L3	0.5±0.1						
L2	8.4±0.2								

3. Part numbering/T.C/Capacitance/ Tolerance :

SAP P/N	T.C.	T.C. Capacitance	
SLSYW100JP00	1K M	10 pF	
SLSYW220JP00		22 pF	. = 0
SLSYW470JP00	SL 《	47 pF)
SLSYW680JP00		68 pF	e
YPSYW101KP00	Na	100 pF	
YPSYW221KP00	Y5P	220 pF	5 300
YPSYW331KP00		Schn 330 pF	±10%
YPSYW471KP00		CHNOLO4700PFORATO	
YUSYW471MP00		470 pF	
YUSYW681MP00	SYW681MP00		1209/
YUSYW102MP00	150	1000 pF	±20%
YUSYW152MP00		1500 pF	
YVSYW222MP00	Y5V	2200 pF	±20%

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4. Marking:

1.Company Name Code(Trade mark)	
2.Type/Series Designation	SYW
3.Code of Dielectric	SL / B(Y5P) / E(Y5U) / F(Y5V)
4.Nominal Capacitance	Identified by 3-Figure Code. Ex. 470pF \rightarrow "471", 1000pF \rightarrow "102"
5.Capacitance Tolerance	J:±5%,K:±10%,M:±20%
6.Class code/Rated Voltage Mark	Y1 / 250V~ ;400V~
7. Safety certification mark	UL/cUL: CALUS ; ENEC: CQC: CCC; KC:
8. Products ID	Abbreviation ex.:
(Manufactured Date code, add as needed)	NB210303
	N:2021 year
	B: Sn-Pb-Ag Solder
	21: Machine and batch (production line traceability)
	03: March
	US:date
JK	Marking sample
COPINICITIES IN THE	SYW E Y1 102M 400V~ C D us Coc ECC 15 C 250V~ NB210303

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5. Scope:

THIS SPECIFICATION APPLIES TO CERAMIC INSULATED CAPACITORS RESIN MOLDING SMD TYPE USED IN ELECTRONIC EQUIPMENT.

5.1Applicable safety standard

This specification applies to the UL/CUL, VDE/ENEC, CQC and KC approved ceramic capacitors resin molding SMD type for antenna coupling, line-by-pass and across-the-line. X1, Y1 capacitor based on IEC60384-14.

5.2 Safety standards approval and recognized no.

Safety Standard	Standard No.	Subclass	w.v.	Recognized No.
UL/CUL	ANSI/UL 60384-14	Y1	250Vac/400Vac	
ENEC	EN 60384-14:2013/A1:2016	Y1	250Vac/400Vac	
CQC	GB/T6346.14	Y1	400Vac	
KC	K60384-14	Y1	250Vac	

5.3 Exemption Clause

2010/571/EU 7(a) : Lead in high melting temperature type solders (i.e. lead-based alloys containing 85 % by weight or more lead)

5.4 Product Structure:



No.	名称 Part name	材料 Material	型号 Model	供应商 Maker
1	包封层 Coating	环氧树脂(UL94V-0 认定品)Epoxy molding compound (Conforming to UL94V-0 standard)	/	CHANGCHUN
2	电极 Electrode	银 Silver/铜 Copper	/	TRX
3	焊料 Solder	Sn-Pb-Ag 系焊料 Sn-Pb-Ag Solder	/	GUOTONG
4	引线 Lead wire	铜系合金 Copper alloys	/	BW
5	介质 Dielectric	陶瓷 Ceramic	全系列 All series	TRX

6. Specification and test method:

6.1 Operating Temperature Range: -40 to +125°C

6.2 Test condition:

Test and measurement shall be made at the standard condition. (temperature $15 \sim 35^{\circ}$ C, relative humidity $45 \sim 75\%$ and atmospheric pressure $860 \sim 1060$ hpa). Unless otherwise specified herein.

If doubt occurred on the value of measurement, and measurement was requested by customer capacitors shall be measured at the reference

condition. (temperature $20\pm2^{\circ}$ C or $25\pm2^{\circ}$ C , relative humidity 60~70% and atmospheric pressure 860~1060 hpa.)

6.3 Performance:

No	Iten	15		Specification	Testing method			1			
1	Appearance and di	mensions	No mark	ed defect on appearance	The capacitor should be inspected by naked eyes for		s for visib	le			
			form and	dimensions.	evidence of defect.						
-			Please re	fer to [Part number list].	Dimensions s	should be	measur	ed with sl	ide calipe	ers.	
2	Marking		To be eas	sily legible.	The capacito	r should I	be inspe	cted by na	aked eye	<u>S.</u>	
3	Dielectric	Between lead	No failure		The capacito	r should i	not be da	amaged w	hen AC4	000V(r.m	.s.)
	Strength	wires			<50/60HZ> 18	applied			wires for	60 S.	
			N. C '1		Charge/Disc	narge cu		SUMA.)			
		Body Insulation	No failure		First, the tern	ninais of	ine capa	Citor shou		nected	
					an aluminum	film arou	ind the h	ody of the	appeu ci	osely will	1
					distance abo	ut 2 to 3n	nm from	each tern	ninal. The	en, put the	e
					capacitor into	the testi	ng jig as	shown in	below fi	gure.	
					Finally, apply	AC4000	V(r.m.s.)	<50/60H	z> for 60	sec.	
					(Charge/Disc	harge cu	rrent ≤	50mA.)			
				水石 何		\sim					
			.3	EPTH S	St.	h <	Tes	t pin			
			1.1	電け四心、	St.						
			NX.	入权区仍合	\sim		P	lastic	insulation		
			tym 1		ED &						
		1	714 4		र् के		┍┓┍┱	Aluminui	n film cla	dding	
	##										
				PASSIVE SYSTEM ALLIAN		~					
4	Insulation Between terminal: Resistance		6000MΩ min.		The insulation resistance should be measured with DC100 \pm 50V within 60 \pm 5 s of charging.						
			The voltage should be applied to the capacitor through			a resistor	of				
5	Capacitance		Within sp	ecified tolerance	Y5PY5U&Y5V: The capacitance shall be measured at $25+3^{\circ}$ C, with					with	
6	Dissipation Factor(DF)	10/1	10105	TS1, 150 \times 15 \times 10						
-	Q)	Char.	Specifications	\mathbb{S} I : The capacitance shall be measured at $25+3^{\circ}$ with 1MHz				h 1MHz+2	20%	
			B(Y5P)	opcomodificito	and 1.0 ± 0.2 Vrms					2070	
			E(Y5U)	2.5% max.							
			F(Y5V)								
			SL	1.0% max.							
			1	11							
7	Temperature Characte	eristic	Char	Canacitance Change							
			B(Y5P)	Within + 10%	The capacitan	ce measur	ement sha	all be mad	e at each s	step specif	ied in
			$E(Y5P)$ Within $\pm 10\%$		Table	r		1			
			F(Y5V)	Within +22/-82%	Step	1	2	3	4	5	
			(Temp ra	nge: -25 to $+85^{\circ}$ C)	Temp (°⊂)	+25+2	-25+2	+25+2	+85+2	+25+2	
			(Temp. re	nge. 2010 100 0)		12012	2012	12012	10012	12012	
			Char.	Capacitance Change	Pro treatment:						
			SI -1000~+350 ppm/°C		Pre-treatment: Canacitor shall be stored at $125+2^{\circ}$ for thour then placed at						
			(Tomp ro	ngo: 120 to 185°C)	* room condition for 24 ± 2 hours before measurements.			eu ui			
			(remp.ra	nye. +20 10 +03 C)				. ·			
8	Solderability of Lead	S	Land wire	should be soldered with	Immerse the c	apacitor ir	a solutic	on of ethan	ol (JIS-K-	8101) and	
			uniform co	bating on the axial	rosin (JIS-K-5	902) (25% Idor colut	o rosin in	weight pro	oportion).		
			direction of	over $3/4$ of the	Immersing spe	rder soluti red: 25+2	5mm/s	0.5 sec.			
			circumfere	ential direction.	Temp, of sold	er: $245\pm5^{\circ}$	C Lead	Free Sold	er (Sn-3.0	Ag-0.5Cu)
	······································	·····	h	· 45 750/ -ture 1 :			_ Lead	- 100 5010	(51 5.0		/
*	room condition" ten	nperature 15~35°C	, numidity	 45~/5%, atmospheric pressu 	ire · 86~106kP	а					

"C" expresses nominal capacitance value (pF).

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No	Ite	ems	Specification	Testing method			
9	Deflection	Appearance	No marked defect. No marked defect. t = 1 t = 1 t = 1.6 t = 1.6 t = 1.6	Solder the capacitor to the test jig(glass epoxy board)shown in Fig.1 Then apply a force in the direction shown in Fig.1. The soldering should be done using reflow method and should be conducted with care so that the soldering is uniform a free of defects such as heat shock. $\begin{array}{c} 20 & 50 \\ \hline & Pressurizing \\ \hline & Pressurize \\ \hline & Flexure=1 \\ \hline & Gapacitance meter \\ \hline & 45 \\ \hline & Fig.1 \end{array}$ (in mm)			
10	Resistance to Soldering Heat	Appearance I.R. Dielectric Strength	No marked defect. 1000 MΩ min. Per item 3	Preheat the capacitor as in table. Immerse the capacitor in solder solution at $260\pm5^{\circ}$ C for 10 ± 1 sec. Let sit at room condition for 24 ± 2 hrs., then measured. Immersing speed: 25 ± 2.5 mm/s Pretreatment for Y5P \times Y5U char. Perform a heat treatment at $150\pm5^{\circ}$ C for GMS arise and then bet sit for 24 ± 2 hrs. of around condition			
		Capacitance Change	B(Y5P) : Within ±10% E(Y5U),F(Y5V) : Within ±20% SL : Within±5% or ±0.5pF, Whichever is large.	Preheating: Step Temperature Time 1 100 to 120°C 1 min. 2 170 to 200°C 1 min.			
11	Vibration Resistance	Appearance	No marked defect. Schnolog ECHNOLOGY COR	Solder the capacitor to the test jig (glass epoxy board). The capacitor should be subjected to a simple harmonic motion having a total amplitude of 1.5mm, the frequency being varied uniformly between the approximate limits of 10 to 55Hz. The frequency range, from 10 to 55Hz and return to 10Hz, should be traversed in approximately 1min. This motion should be applied for a period of 2hrs.in each of 3 mutually perpendicular directions (total of 6hrs.).			
12	Passive Flamma	ıbility	The burning time shall not be exceeded the time 30 sec. The tissue paper shall not ignite.	The capacitor under test shall be held in the position which best promotes burning. Each specimen shall only be exposed once to flame. Time of exposure to flame: 30sec. Length of flame : 12±1mm Gas burner: Length 35mm min. Inside Dia. : 0.5±0.1mm Outside Dia. : 0.9mm max. Gas: Butane gas Purity 95% min. Gas: Butane gas Purity 95% min.			

 $\label{eq:condition} \mbox{``room condition'' temperature $$: 15~35^{\circ}C$, humidity $$: 45~75\%$, atmospheric pressure $$: 86~106kPa$ }$

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No	o Items		Specification	Testing method			
13	Life	Appearance Capacitance Change	No marked defect. B(Y5P),E(Y5U),F(Y5V) : Within ±20% SL : Within±5% or ±1.0pF, Whichever is large.	Impulse Voltage Each individual capacitor shall be subjected to 8kV impulses for three times. After the capacitors are applied to life test. The waveform will be determined by the test circuit parameters. Details of the test circuit are given in IEC 60384-14 Annex A. 100 (%) Front time (T1) =1.2µs=1.67T			
		I.R. Dielectric Strength	3000MΩ min. Per Item 3	Time to half-value (12) = 50µs $30 \xrightarrow{0} \xrightarrow{1} \xrightarrow{1} \xrightarrow{1} \xrightarrow{1} \xrightarrow{1} \xrightarrow{1} \xrightarrow{1} 1$			
14	Active Flammability		The cheesecloth shall not be on fire.	The specimens shall be individually wrapped in at least one but more than two complete layers of cheesecloth. The specimens shall be subjected to 20 discharges. The interval between successive discharges shall be 5 sec. The UAC shall be maintained for 2 min after the last discharge. I = I = I = I = I = I = I = I = I = I =			

 $\label{eq:condition} \mbox{``room condition'' temperature : $15~35^{\circ}\C, humidity : 45~75\%, atmospheric pressure : $86~106 kPa \label{eq:condition} \mbox{''}$

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No	o Items		Specification	Testing method			
15	Humidity (Under Steady State)	Appearance Capacitance Change	No marked defect B(Y5P) : Within ±10% E(Y5U),F(Y5V) : Within ±20% SL : Within±5% or ±1.0pF, Whichever is large.	Sit the capacitor at 40±2°C and relative humidity 90 to 95% for 500+24/-0h. Remove and let sit for 24±2h at room condition*, then measure. Pre-treatmen:			
		D.F.	Char.SpecificationsB(Y5P)E(Y5U)5.0% max.F(Y5V)SL1.0% max.	Capacitor should be stored at 150+0/-10°C for 1h, and apply the AC4000V(r.m.s.) 60s then placed at room condition* for 24±2h berore initial measurements.			
		I.R. Dielectric	B(Y5P),E(Y5U),F(Y5V) : 3000MΩ min. SL : 1000MΩ min.				
		strength	Per item 3				
16	Humidity Loading	Appearance Capacitance Change	No marked defect B(Y5P): Within ±10% E(Y5U),F(Y5V): Within ±20% SL: Within±5% or ±1.0pF, Whichever is large.	Apply the rated voltage at 40 ± 2 °C and relative humidity 90 to 95% for 500+24/-0h. Remove and let sit for 24±2h at room condition*, then measure.			
		I.R.	B(Y5P),E(Y5U),F(Y5V) ; 3000MΩ min. SL : 1000MΩ min.	Pre-treatmen: Capacitor should be stored at 150+0/-10°C for 1h, and apply the AC4000V(r.m.s.) 60s then placed at room condition* for 24+2h berore initial measurements			
		strength	Per Item 3				
17	Temperature Cycle	Appearance	No marked defect	The capacitor should be subjected to 5 temperature cycles, <temperature 5cycles="" cycle="" time:=""></temperature>			
		Change	Char.Capacitance ChangeB(Y5P)Within ± 10%E(Y5U)Within ± 20%F(Y5V)Within ± 20%SLWithin ± 10%	Step Temperature(°C) Time(min) 1 -40+0/-3 30 2 Room temp. 3 3 125+3/-0 30 4 Room temp. 3			
		D.F.	Char. Specifications B(Y5P) 5.0% max. E(Y5U) 7.5% max. F(Y5V) 7.5% max. SL 1.0% max.	 Pre-treatment: Capacitor shall be stored at 150±5°C for 1hour.then placed at ^{**1}room condition for 24±2hours before initial measurements. Post-treatment: Capacitor shall be stored for 1 to 2hours at ^{**1}room condition. 			
		I.R.	3000MΩ min.				
		Dielectric strength	Per Item .3]			

* "room condition" temperature : 15~35°C, humidity : 45~75%, atmospheric pressure : 86~106kPa

* "C" expresses nominal capacitance value (pF).

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7.Packing Description :





Reel Drawing



Inner-packaging 内包装 ex.:

	(1) P/N: (0) Oty: 500PCS	No.	Item
	- Wilder THY1101K (0) Pote Code 171172	1	P/N 客户料号
Label		2	Qty 数量
	5 1)Lot#:SMDY1101K171129C SPEC: SMD-Y1101K/AC400V	3	Mfr 料号
	Rohs LK	4	Date Code 生产日期
	UK - SMD Y CAP	5	Lot# 生产批号
Reel Size: 13inch 3.0Kpcs/Reel	Label 标签	6	SPEC 规格

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8. Caution:

8.1 Operating voltage

When DC-rated capacitors are to be used in AC or ripple current circuits, be sure to maintain the Vp-p value of the applied voltage or the Vo-p

which contains DC bias within the rated voltage range.

When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of

resonance or switching. Be sure to use a capacitor within rated voltage containing these irregular voltage.

Voltage	DC Voltage	DC+AC Voltage	AC Voltage		
Positional measurement	V0-p		Vp-p		

8.2 Operating temperature and self-generated heat

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat

generated by the capacitor itself.

8.3 Test condition for withstanding voltage

(1) Test equipment

Test equipment for AC withstanding voltage should be used with the performance of the wave similar to 50/60 Hz sine wave.

If the distorted sine wave or over load exceeding the specified voltage value is applied, the defective may be caused.

(2) Voltage applied method

When the withstanding voltage is applied, capacitor's lead or terminal should be firmly connected to the out-put of the withstanding voltage test equipment, and then the voltage should be raised from near zero to the test voltage.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, test voltage should be applied with the *zero cross. At the end of the test time, the test voltage should be reduced to near zero, and then capacitor's lead or terminal should be taken off the out-put of the

withstanding voltage test equipment.

If the test voltage without the raise from near zero voltage would be applied directly

to capacitor, the surge voltage may arise, and therefore, the defective may be caused.

*ZERO CROSS is the point where voltage sine wave pass 0V.

- See the right figure -

8.4 Fail-Safe

When capacitor would be broken, failure may result in a short circuit. Be sure to provide an appropriate fail-safe function like a fuse on your

product if failure would follow an electric shock, fire or fume.

8.5 Vibration and impact

Do not expose a capacitor or its leads to excessive shock or vibration during use.



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8.6 Soldering

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to

excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

When soldering capacitor with a soldering iron, it should be performed in following conditions.

Temperature of iron-tip : 400° C max.

Soldering iron wattage : 50W max.

Soldering time : 3.5s max.

8.7 Bonding, resin molding and coating

In case of bonding, molding or coating this product, verify that these processes do not affect the quality of capacitor by testing the performance of the bonded, molded or coated product in the intended equipment.

In case of the amount of applications, dryness / hardening conditions of adhesives and molding resins containing organic solvents (ethyl acetate,

methyl ethyl ketone, toluene, etc.) are unsuitable, the outer coating resin of a capacitor is damaged by the organic solvents and it may result, worst case, in a short circuit.

The variation in thickness of adhesive, molding resin or coating may cause a outer coating resin cracking and/or ceramic element cracking of a

capacitor in a temperature cycling.

8.8 Treatment after bonding, resin molding and coating

When the outer coating is hot (over 100 $^\circ$ C) after soldering, it becomes soft and fragile.

So please be careful not to give it mechanical stress.

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

8.9 Operating and storage environment

The insulating Epoxy molded capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding or molding this product, verify that these processes do not affect produce quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. This one is MSL 3 product. So, in order to avoid the absorption of moisture, capacitors are packed in moisture-proof envelope. Store the capacitors in the following conditions at all times, and use within 6 months after delivered.

Temperature:10 to 30 $^\circ\!\mathrm{C}$

Humidity : 60% max.

Solder the enclosed capacitors within 168 hours after opening the moisture-proof package. After opening, store the capacitors in moisture-proof package with a desiccant and HIC card and keep the above condition.

In case the storage period has been exceeded 6 months or the indicator color of a enclosed HIC card has changed when the package has been opened, perform baking $(60^{\circ}C \times 168hr)$ before soldering.

When the product is unpacked, the exposure time exceeds Floor time, the temperature and humidity around the product exceed the requirement.

Reference condition for drying mounted or unmounted SMD packages (user bake: Floor life begins at time=0 after bake)

Level	Bake@40°C ≤5%RH							
	Saturated@30°C/85%RH	At limit of Floor life+72hr@30°C/60RH						
3	79days	67days						

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

8.10 Limitation of applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects

which might directly cause damage to the third party's life, body or property.

- 1. Aircraft equipment
- 2. Aerospace equipment
- 3. Undersea equipment
- 4. Power plant control equipment
- 5. Medical equipment
- 6. Transportation equipment (vehicles, trains, ships, etc.)
- 7. Traffic signal equipment
- 8. Disaster prevention / crime prevention equipment
- 9. Data-processing equipment exerting influence on public
- 10. Application of similar complexity and/or reliability requirements to the applications listed in the above.



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9. Notices:

9.1 Cleaning (ultrasonic cleaning):

To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity : Output of 20 watts per liter or less.

Rinsing time : 5 min maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

9.2 Capacitance change of capacitors

Class 1 capacitors

Capacitance might change a little depending on a surrounding temperature or an applied voltage.

Please contact us if you use for the strict time constant circuit.

Class 2 capacitors

Class 2 capacitors like temperature characteristic B and E have an aging characteristic, whereby the capacitor continually decreases its capacitance

slightly if the capacitor leaves for a long time. Moreover, capacitance might change greatly depending on a surrounding temperature or an applied

voltage. So, it is not likely to be able to use for the time constant circuit.

Please contact us if you need a detail information.

9.3 Performance check by equipment

Before using a capacitor, check that there is no problem in the equipment's performance and the specifications.

Generally speaking, CLASS 2 ceramic capacitors have voltage dependence characteristics and temperature dependence characteristics in capacitance.

So, the capacitance value may change depending on the operating condition in a equipment. Therefore, be sure to confirm the apparatus performance of PASSIVE SYSTEM ALLIANCE receiving influence in a capacitance value change of a capacitor, such as leakage current and noise suppression characteristic.

Moreover, check the surge-proof ability of a capacitor in the equipment, if needed, because the surge voltage may exceed specific value by the inductance of the circuit.

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10. Note

10.1 Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.

10.2 You are requested not to use our product deviating from this specification.

10.3 Do not use these products in any Automotive Power train or Safety equipment including Battery charger for Electric Vehicles and Plug-in Hybrid.

Safety	Standard	Certified	Resin	Molding	SMD	Туре	Ceramic	DOE D21 00 E 01	Vor: 01	Deces 1	7 1	17
Capaci	tors for Ge	neral Purp	oose SY	W Series (Y1:250	V~/400	V~)	POE-D31-00-E-01	vei. 01	Page: 1	. / /	1/

11. Soldering Recommendation:

11.1 Soldering Land Pattern Size:



Dimension	a(mm)	b(mm)	c(mm)
7.8x5.4	7.8	2.2	3.6

11.2 Reflow Soldering Temperature Profile :



Zone		Temp. range (°C)	Time(sec)	Remark
а	Curing	RT~130	60	
b	Preheat	180 max	150~210	Solder: Sn-Ag-Cu
С	Soldering	220~260(260 max)	60~110	Peak time: less than 10 sec
d	Cooling	220~RT	60 min	

Solder ability of tin plating termination pins might be deteriorated when a low temperature soldering profile where the peak solder temperature is below the melting point of tin is used. Please confirm the solder ability of tin plated termination pins before use

The maximum temperature in the air outlet and the space of Reflow soldering is 280°C max., if the temperature exceed, it maybe a failure occur. Our company will not be held responsible for any adverse effects caused by over temperature using

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